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| APPLICATION NO. | F | FILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO. |
|-------------------------|--------------------------|-------------|----------------------|------------------------|------------------|
| 09/986,997 | | 11/13/2001 | Kenji Orita | 740819-617 | 6386 |
| 22204 | 7590 | 09/21/2004 | | EXAMINER | |
| NIXON PE | | | PHAM, LONG | | |
| 401 9TH ST SUITE 900 | REEI, N | W | | ART UNIT | PAPER NUMBER |
| WASHING | ASHINGTON, DC 20004-2128 | | | 2814 | |
| | | | | DATE MAILED: 09/21/200 | 4 |

Please find below and/or attached an Office communication concerning this application or proceeding.

| | Application No. | Applicant(s) | | | | | | |
|--|---|---|---------|--|--|--|--|--|
| | 09/986,997 | ORITA ET AL. | | | | | | |
| Office Action Summary | Examiner | Art Unit | | | | | | |
| | Long Pham | 2814 | | | | | | |
| The MAILING DATE of this communicatio Period for Reply | n appears on the cover sheet w | ith the correspondence address | | | | | | |
| A SHORTENED STATUTORY PERIOD FOR R THE MAILING DATE OF THIS COMMUNICATI - Extensions of time may be available under the provisions of 37 C after SIX (6) MONTHS from the mailing date of this communicatic - If the period for reply specified above is less than thirty (30) days - If NO period for reply is specified above, the maximum statutory - Failure to reply within the set or extended period for reply will, by Any reply received by the Office later than three months after the earned patent term adjustment. See 37 CFR 1.704(b). | ON. FR 1.136(a). In no event, however, may a on. a reply within the statutory minimum of thin period will apply and will expire SIX (6) MOI statute, cause the application to become A | reply be timely filed ty (30) days will be considered timely. ITHS from the mailing date of this communic BANDONED (35 U.S.C. § 133). | ation. | | | | | |
| Status | | | | | | | | |
| 1) Responsive to communication(s) filed on | • | | | | | | | |
| 2a) This action is FINAL . 2b) ⊠ | This action is non-final. | | | | | | | |
| ,— | Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. | | | | | | | |
| Disposition of Claims | | | | | | | | |
| 4)⊠ Claim(s) <u>1-15 and 39-43</u> is/are pending in 4a) Of the above claim(s) is/are wit | | | | | | | | |
| 5)⊠ Claim(s) <u>1-15</u> is/are allowed. | | | | | | | | |
| 6)⊠ Claim(s) <u>39-43</u> is/are rejected. | Claim(s) <u>39-43</u> is/are rejected. | | | | | | | |
| 7) Claim(s) is/are objected to. | Claim(s) is/are objected to. | | | | | | | |
| 8) Claim(s) are subject to restriction a | and/or election requirement. | | | | | | | |
| Application Papers | | | | | | | | |
| 9) The specification is objected to by the Exa | miner. | | | | | | | |
| 0) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner. | | | | | | | | |
| Applicant may not request that any objection t | Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a). | | | | | | | |
| Replacement drawing sheet(s) including the c | • | | | | | | | |
| , | le Examiner. Note the attache | Joince Action of Joint 10-102 | | | | | | |
| Priority under 35 U.S.C. § 119 | | | | | | | | |
| 12) Acknowledgment is made of a claim for fo a) All b) Some * c) None of: 1. Certified copies of the priority docu 2. Certified copies of the priority docu 3. Copies of the certified copies of the application from the International B | ments have been received. ments have been received in A priority documents have beer | application No | | | | | | |
| * See the attached detailed Office action for | a list of the certified copies not | received. | | | | | | |
| Attachment(s) 1) Notice of References Cited (PTO-892) | 4) Intention | Summary (PTO-413) | | | | | | |
| 2) Notice of Draftsperson's Patent Drawing Review (PTO-94 | 8) Paper No(| s)/Mail Date | | | | | | |
| Information Disclosure Statement(s) (PTO-1449 or PTO/S Paper No(s)/Mail Date | 5B/08) 5) Notice of l 6) Other: | nformal Patent Application (PTO-152) | | | | | | |

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DETAILED ACTION

Claim Rejections - 35 USC § 103

1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 39 and 40 are rejected under 35 U.S.C. 103(a) as being unpatentable over the applicant's admitted prior art of this present application in view of Isamu et al. (Japan 02257679) (a reference of record) and Shih et al. (US '320) (a reference of record).

The applicant's admitted prior art teaches a method for fabricating a semiconductor device, comprising the steps of (see col. 1, line 5 to col. 2, line 61 of the Background and figure 10 of the patent no. 6,117,700):

- a) forming a semiconductor layer 104 of a group III nitride containing a dopant over a substrate 101, wherein the dopant includes magnesium (Mg), zinc (Zn), calcium (Ca), strontium (Sr), and beryllium (Be);
- b) forming a p-side electrode out of a metal on the semiconductor layer, wherein the metal includes nickel and gold; and
- c) exposing the semiconductor layer to plasma at temperature, thereby making the conductivity type of semiconductor layer p-type.

The applicant's admitted prior art teaches exposing the semiconductor layer to plasma for activating the p-type dopant at a temperature, but fails to teach annealing temperature range of 600°C or less as recited in present claim 39.

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Isamu teaches a method of making a gallium nitride compound semiconductor light-emitting device in which a group III nitride containing a dopant is exposed to heat at a temperature of 600°C or less. See the English abstract and figure 5.

It would have been obvious to *one of <u>ordinary skill</u> in the art of making semiconductor devices* to expose the group III nitride containing a dopant to heat at temperature of 600°C or less in the method of the applicant's admitted prior art because in doing so the optical characteristics of the device are improved without changing electrical characteristics. See the English abstract.

The applicant's admitted prior art teaches performing plasma heating after the formation of the semiconductor layer 104 of a group III nitride containing a dopant, but fails to teach that the plasma heating is done in the presence of nitrogen.

Shih teaches a method of forming a semiconductor layer in which a semiconductor layer of a group III nitride containing a dopant is annealed by nitrogen plasma. See the abstract.

It would have been obvious to *one of <u>ordinary skill</u> in the art of making* semiconductor devices to anneal the semiconductor layer 104 of a group III nitride containing a dopant by nitrogen plasma in the method of the applicant's admitted prior art because in doing so the unwanted defects caused by high temperature process are prevented. See the abstract.

3. Claims 41-43 are rejected under 35 U.S.C. 103(a) as being unpatentable over the applicant's admitted prior art of this present application in view of Isamu et al. (Japan 02257679) as applied to claims 39 and 40 above, and further in view of Nagao (Japan 58100471).

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The applicant's admitted prior art teaches forming the p-side electrode out of metal on the semiconductor layer, but fails to teach that the metal is aluminum as recited in present claims 41-43.

Nagao teaches a method of making a light-emitting diode in which the p-side electrode is made of aluminum. See the English abstract.

It would have been obvious to *one of <u>ordinary skill</u> in the art of making* semiconductor devices to form the p-side electrode from aluminum in the method of the applicant's admitted prior art because in doing the life and reliability of the device is improved. See the English abstract.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Long Pham whose telephone number is 571-272-1714. The examiner can normally be reached on M-F, 7:30AM-3:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on 571-272-1705. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Long Pham

Primary Examiner

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